

**IGBT** 

# FMG2G150US60

## **Molding Type Module**

## **General Description**

Fairchild IGBT Power Module provides low conduction and switching losses as well as short circuit ruggedness. It's designed for the applications such as motor control, uninterrupted power supplies (UPS) and general inverters where short-circuit ruggedness is required.

## **Features**

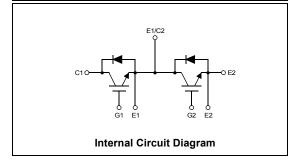
- Short Circuit Rated Time; 10us @  $T_C = 100$ °C,  $V_{GE} = 15V$
- · High Speed Switching
- Low Saturation Voltage : V<sub>CE</sub>(sat) = 2.1 V @ I<sub>C</sub> = 150A
- · High Input Impedance
- Fast & Soft Anti-Parallel FWD
- · UL Certified No.E209204

## **Application**

- AC & DC Motor Controls
- · General Purpose Inverters
- Robotics
- · Servo Controls
- UPS



Package Code: 7PM-HA



# **Absolute Maximum Ratings** T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Description	FMG2G150US60	Units	
V <sub>CES</sub>	Collector-Emitter Voltage		600	V
V <sub>GES</sub>	Gate-Emitter Voltage		± 20	V
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 80°C	150	Α
I <sub>CM (1)</sub>	Pulsed Collector Current		300	Α
I <sub>F</sub>	Diode Continuous Forward Current	@ T <sub>C</sub> = 80°C	150	Α
I <sub>FM</sub>	Diode Maximum Forward Current		300	Α
$P_{D}$	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	595	W
T <sub>SC</sub>	Short Circuit Withstand Time @ T <sub>C</sub> = 100°C		10	us
T <sub>J</sub>	Operating Junction Temperature		-40 to +150	°C
T <sub>STG</sub>	Storage Temperature Range		-40 to +125	°C
V <sub>ISO</sub>	Isolation Voltage	@ AC 1minute	2500	V
Mounting Torque	Power Terminal Screw : M5		4.0	N.m
Mounting Torque	Mounting Screw : M6		4.0	N.m

#### Notes :

(1) Repetitive rating : Pulse width limited by max. junction temperature

Symbol	Parameter Test Conditions		Min.	Тур.	Max.	Units
Off Cha	racteristics					
BV <sub>CES</sub>	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250uA$	600			V
ΔB <sub>VCES</sub> / ΔΤ <sub>J</sub>	Temperature Coeff. of Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 1mA		0.6		V/°C
I <sub>CES</sub>	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$			250	uA
I <sub>GES</sub>	Gate - Emitter Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$			± 100	nA

#### On Characteristics

V <sub>GE(th)</sub>	Gate - Emitter Threshold Voltage	$I_C$ = 150mA, $V_{CE}$ = $V_{GE}$	5.0	6.5	8.5	V
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage	$I_C = 150A$ , $V_{GE} = 15V$		2.1	2.7	V

## **Switching Characteristics**

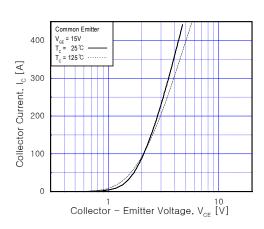
t <sub>d(on)</sub>	Turn-On Delay Time			140		ns
t <sub>r</sub>	Rise Time	)/ 000 \/ l 4504		80	-	ns
$t_{d(off)}$	Turn-Off Delay Time	$V_{CC} = 300 \text{ V, } I_{C} = 150 \text{A,}$		120	-	ns
t <sub>f</sub>	Fall Time	$R_G = 2\Omega$ , $V_{GE} = 15V$ , Inductive Load, $T_C = 25^{\circ}C$		130	250	ns
t <sub>f</sub> E <sub>on</sub>	Turn-On Switching Loss	middelive Load, 1 <sub>C</sub> = 25 C		2.3	-	mJ
E <sub>off</sub>	Turn-Off Switching Loss			4.7	-	mJ
t <sub>d(on)</sub>	Turn-On Delay Time			180	-	ns
t <sub>r</sub>	Rise Time	)/ 000 \/ l 4504		90	-	ns
$t_{d(off)}$	Turn-Off Delay Time	$V_{CC} = 300 \text{ V, } I_{C} = 150 \text{A,}$ $R_{G} = 2\Omega, V_{GE} = 15 \text{V,}$ Inductive Load, $T_{C} = 125^{\circ}\text{C}$		150	-	ns
t <sub>f</sub>	Fall Time			270	-	ns
t <sub>f</sub> E <sub>on</sub>	Turn-On Switching Loss	middelive Load, 1 <sub>C</sub> = 125 C		3.1	-	mJ
E <sub>off</sub>	Turn-Off Switching Loss			7.7	-	mJ
T <sub>sc</sub>	Short Circuit Withstand Time	V <sub>CC</sub> = 300 V, V <sub>GE</sub> = 15V @ T <sub>C</sub> = 100°C	10			us
$Q_g$	Total Gate Charge			460	-	nC
Q <sub>ae</sub>	Gate-Emitter Charge	$V_{CE} = 300 \text{ V, I}_{C} = 150 \text{A,}$		130		nC
Q <sub>ge</sub>	Gate-Collector Charge	V <sub>GE</sub> = 15V		190		nC

# Electrical Characteristics of DIODE $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Condi	tions	Min.	Тур.	Max.	Units
V <sub>FM</sub> Diode Fo	Diode Forward Voltage	ard Voltage   I <sub>E</sub> = 150A   —	T <sub>C</sub> = 25°C		1.9	2.8	V
	Diode i diward voltage		T <sub>C</sub> = 100°C		1.8		, v
+	A Diada Davarra Dasavar Tiras		T <sub>C</sub> = 25°C		90	130	no
t <sub>rr</sub>	Diode Reverse Recovery Time	T <sub>C</sub> = 1	T <sub>C</sub> = 100°C		130		ns
	Diode Peak Reverse Recovery	I <sub>F</sub> = 150A	$T_C = 25^{\circ}C$		15	20	Α
<sup>I</sup> rr	Current	urrent $di / dt = 300 \text{ A/us}$ $T_C = 100^{\circ} \text{C}$	T <sub>C</sub> = 100°C		22		_ ^
Q <sub>rr</sub>	Diode Reverse Recovery Charge		T <sub>C</sub> = 25°C		675	1270	200
			T <sub>C</sub> = 100°C		1430		nC

# **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Units
$R_{ heta JC}$	Junction-to-Case (IGBT Part, per 1/2 Module)		0.21	°C/W
$R_{\theta JC}$	Junction-to-Case (DIODE Part, per 1/2 Module)		0.48	°C/W
$R_{\theta JC}$	Case-to-Sink (Conductive grease applied)	0.045		°C/W
Weight	Weight of Module	240		g



250 V<sub>GE</sub> = 10V 150 0 1 2 3 4 Collector - Emitter Voltage, V<sub>CE</sub> [V]

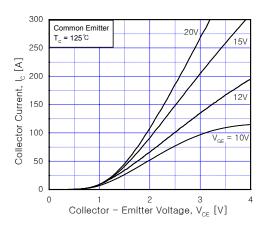
Fig 1. Typical Output Characteristics

Fig 2. Typical Saturation Voltage Characteristics

300

Common Emitter

T\_ = 25°C



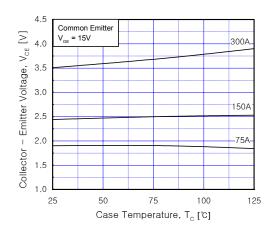
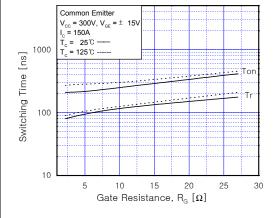


Fig 3. Typical Saturation Voltage Characteristics

Fig 4. Saturation Voltage vs. Case
Temperature at Variant Current Level



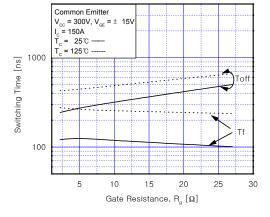


Fig 5. Turn-On Characteristics vs.

Gate Resistance

Fig 6. Turn-Off Characteristics vs.
Gate Resistance

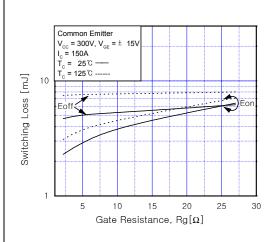


Fig 7. Switching Loss vs. Gate Resistance

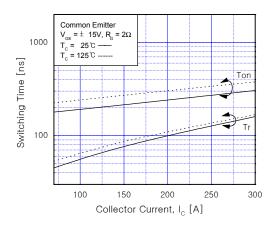


Fig 8. Turn-On Characteristics vs. Collector Current

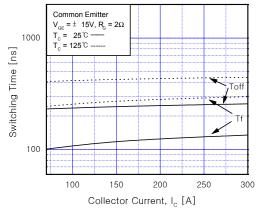


Fig 9. Turn-Off Characteristics vs. Collector Current

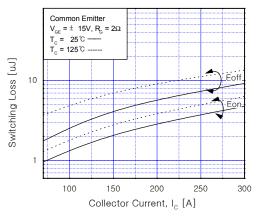


Fig 10. Switching Loss vs. Collector Current

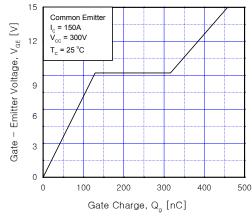


Fig 11. Gate Charge Characteristics

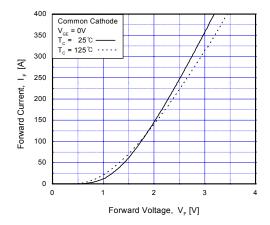


Fig 12. Forward Characteristics(diode)

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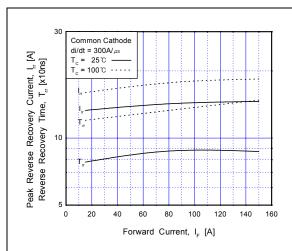
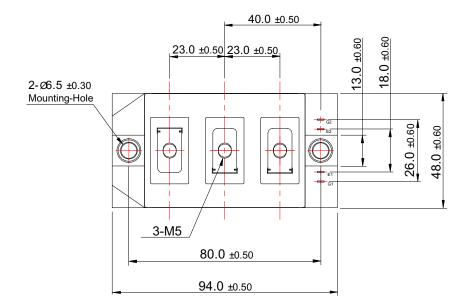
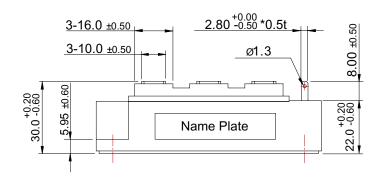


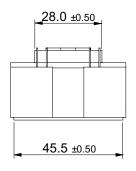
Fig 13. Reverse Recovery Characteristics(diode)

# **Package Dimension**

# 7PM-HA







Dimensions in Millimeters

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